ASSOCIATION CONNECTING LECTRONICS INDUSTRIES® INCLUSTRIES	PC. Bannockl	burn. Illinois. A	Il rights reserved untions.	under both	This docume level parts, t	ent is a declarati he declaration e	on of the su	ibstances s all lower	within the manuf r level materials	acturer lister	d item. Note e manufactu	e: if the item is an a rer has engineering	assembly with lower g responsibility.	
	I.1IPC Web Site for Information on IPC-1752 Standard http://www.ipc.org/IPC-175xFor Dis									laterials and	als and Mfg Information			
Supplier Information														
Company name*	Company un	Company unique ID			Unique ID Authority					Response Date*				
onsemi						1				2024-	2024-05-04			
Contact Name Title - Contac			tact			Phone - Contact*				Email	Email - Contact*			
Product-Env-Stewards Produc			roduct Enviro Compliance			NA				Prod	Product-Env-Stewards@onsemi.com			
Authorized Representative* Title -			itle - Representative			Phone - Representative*				Emai	Email - Representative*			
Product-Env-Stewards Produ			Product Enviro Compliance			NA				Prod	Product-Env-Stewards@onsemi.com			
Requester Item Number	Mfr Iten	n Number	ber Mfr Item Name		· · · ·	Effective Date	Version	N	Manufacturing Site		Weight*	UOM	Unit Type	
	CNY171	ISR2VM	6PW TR T&R VDE			2024-05-04		1	ТНН		464.903	mg	Each	
Manufacturing Proccess Informa	tion						-				-			
Terminal Plating / Grid Array M	aterial 7	Ferminal Base	Alloy J-STD-020 MSL Ra		Rating	Peak Proc	ess Body Temperature Max Time		e Max Time at	Peak Tempe	k Temperature Number of Reflow Cycles		vcles	
Matte Tin (Sn) - annealed CU A		CU Alloy	1			260 C 30		sec	seconds 3					
Comments														
evel 1 - maximum time at peak temperatu	ire during so	ldering is 10-3	0 seconds											
for more information regarding material	composition	please refer to	page 3											

RoHS Material Composition Declaration				Declaration Type *	Detailed						
Directive 2015/863/EU amending RoHS Directive 2011/65/EU	(Pb), Mercury (Hg), Hexavalent Chror	Definition: Quantity limit of 0.01% by mass (100 PPM) in homogeneous material for Cadmium and quantity limit of 0.1% by mass (1000 PPM) in homogeneous material for: Lead Mercury (Hg), Hexavalent Chromium (Cr6+), Polybrominated Biphenyls (PBB), Polybrominated Diphenyl Ethers (PBDE), and Bis(2-ethylhexyl) phthalate (DEHP), Benzyl-butyl late (BBP), Dibutyl phthalate (DBP), Diisobutyl phthalate (DIBP). s defined by the RoHS Directive, EU 2011/65/EU and implemented by the laws of the European Union member states) of the part identified on this form contains lead, mercury,									
cadmium, hexavalentchromium, polybrominate contains a RoHS restricted substance inexcess encompass all such components. Supplier certif as of the date that Supplier completes this form Company acknowledges that Supplier may hav independently verified information provided by certification in this paragraph. If the Company a	ed biphenyls and/or polybrominated dip of an applicable quantity limit, please ir ies that it gathered the information it pro- .Supplier acknowledges that Company e relied on informationprovided by othe y others, Supplier agrees that, at a minin and the Supplier enter into a written agre pource of the Supplier's liability and the	henyl ethers (each a " ndicate below which, i ovides in this form us will rely on this certifiers in completing this num, itssuppliers have eement with respect to Company's remedies	RoHS restricted substance") in exce if any, RoHS exemption you believe ing appropriate methods to ensure if ication in determining the complian form, and that Supplier may not have e provided certifications regarding the to the identified part, the terms and cc for issues that arise regarding inform	ess of the applicable quantity limit identified about the may apply. If the part is an assembly with low is accuracy and that such information is true and ce of its products with European Union member we independently verified such information. How	ove. If a homogeneous material within the part er level components, the declaration shall l correct to the best of its knowledge and belief, r state laws that implement the RoHS Directive. wever, in situations where Supplier has not tions are at least as comprehensive as the anty rights and/or remedies provided as part of						
RoHS Declaration * 1 - Item(s)	does not contain RoHS restricted substa	on above	Supplier Acceptance	* Accepted							
Exemption: If the declared item does not contain RoHS restricted substances per the definition above except for defined RoHS exemptions, then select the corresponding response in the RoHS Declaration above and choose all applicable exemptions.											
Exemption List Version	EL-2011/534/EU										
Declaration Signature											
Instructions: Complete all of the required fin Requester) and click on Submit Form to have	elds on all pages of this form. Select the form returned to the Requester	he "Accepted" on th	e Supplier Acceptance drop-down	. This will display the signature area. Digital	lly sign the declaration (if required by the						
Supplier Digital Signature Ra	stislav Drska	Le									

## Homogeneous Material Composition Declaration for Electronic Products

SubItem Instructions: The presence of any JIG Level A or B substances must be declared. [1] indicate the subpart in which the substance is located, [2] provide a description of the homogeneous material [3], enter the weight of the homogeneous material.

Homogeneous Material	Weight	Unit of Measure	Level	Substance	CAS	Exempt	Weight	Unit of Measure
Coupling Gel	0.4	mg	Supplier	Dimethyl Cyclosiloxanes	69430-24-6		0.04	mg
			Supplier	Trimethoxy(methyl)silane (C4H12O3Si)	1185-55-3		0.36	mg
Die	5.13	mg	Supplier	Silicon (Si)	7440-21-3		5.13	mg
Die Attach	0.3	mg	Supplier	Silver (Ag)	7440-22-4		0.225	mg
			Supplier	Phenolic Resin-2	54208-63-8		0.075	mg
Lead Frame I	101.703	mg	Supplier	Silver (Ag)	7440-22-4		0.407	mg
			Supplier	Zinc (Zn)	7440-66-6		0.203	mg
			Supplier	Iron (Fe)	7439-89-6		2.64	mg
			Supplier	Copper (Cu)	7440-50-8		98.3	mg
			Supplier	Phosphorus (P)	7723-14-0		0.153	mg
Mold Compound-White	327.22	mg	Supplier	Titanium Dioxide (TiO2)	13463-67-7		81.805	mg
			В	Brominated Bisphenol A Diglycidyl Ether	40039-93-8		9.8166	mg
			Supplier	Ortho Cresol Novolac Resin	29690-82-2		44.1747	mg
			В	Antimony Trioxide (Sb2O3)	1309-64-4		9.8166	mg
			Supplier	Fused Silica (SiO2)	60676-86-0		163.61	mg
			Supplier	Phenolic Resin (Novolac)	9003-35-4		17.9971	mg
Plating	28.5	mg	Supplier	Tin (Sn)	7440-31-5		28.5	mg
Wire Bond - Au	1.65	mg	Supplier	Gold (Au)	7440-57-5		1.65	mg